L Number	Hits	Search Text	DB	Time stamp
1	1	5461545.pn. and transparent	USPAT	2002/07/31 14:53
-	1	4300184.pn.	USPAT	2002/02/25 14:26
-	4	chip same (indicia or marking\$) same transparent same cover	USPAT	2002/02/25 14:29
_	39	chip same (indicia or marking\$) same cover	USPAT	2002/02/25 14:35
	62	(semiconductor or chip) same label\$ same cover	USPAT	2002/02/25 14:43
_	0	235/454.pn.	USPAT	2002/02/25 14:43
-	1047	235/454.ccls.	USPAT	2002/02/25 14:43
- 1	11	235/454.ccls. and (label same cover)	USPAT	2002/02/25 14:48
<b>-</b>	0	235/454.ccls. and (lin.in)	USPAT	2002/02/25 14:48
-	2	235/454.ccls. and (lee.in.)	USPAT	2002/02/25 14:50
-	579	(semiconductor or ic or "integrated circuit" or chip or	USPAT	2002/02/25 15:07
		electronic or device) same (cover or encapsul\$ or coat\$ or		
		layer or packag\$) same transparent same (indicia or label or marking\$)		
_	396	(semiconductor or ic or "integrated circuit" or chip or device)	USPAT	2002/02/25 15:11
		same (cover or encapsul\$ or coat\$ or layer or packag\$)	001711	2002/02/20 10:11
		same (indicia or label or mark\$) same identification		
_	144	(semiconductor or ic or "integrated circuit" or chip) same	USPAT	2002/02/25 15:21
	•	(cover or encapsul\$ or coat\$ or layer or packag\$) same	33.71	2002/02/20 10.21
		(indicia or label or mark\$) same identification		·
_	40592	(semiconductor or ic or "integrated circuit" or chip) same	USPAT	2002/02/25 15:22
	10002	(encapsul\$ or packag\$)	00171	2002/02/20 10.22
_	9474	(semiconductor or ic or "integrated circuit" or chip) same	USPAT	2002/02/25 15:41
_	5474	(encapsul\$)	OGFAT	2002/02/23 13.41
_	136	(transmissive or transparent) same (marking\$ or indicia)	USPAT	2002/02/25 15:45
_	150	same surface same (chip or ic or circuit)	USFAI	2002/02/23 13.43
	4	chip same (label or marking or indicia) same (embed\$ or	USPAT	2002/02/25 15:52
_	7	embos\$ or form\$) same surface same cover	USFAT	2002/02/23 15.52
	75	chip same (label or marking or indicia) same (embed\$ or	USPAT	2002/02/25 15:52
-	, ,	embos\$ or imprint\$)	USFAI	2002/02/23 13.32
_	18	chip same (label or marking or indicia) same (embed\$ or	USPAT	2002/02/25 15:55
		embos\$ or imprint\$) same identif\$	001 71	2002/02/23 13.33
_	11366	(circuit or chip or semiconductor) same (label or marking or	USPAT	2002/02/25 16:00
_	11300	indicia)	00171	2002/02/23 10.00
_ !	1372	((circuit or chip or semiconductor) same (label or marking or	USPAT	2002/02/25 15:59
	1072	indicia)) and transparent and cover\$	001 71	2002/02/20 10:00
_	59983	(circuit or chip or semiconductor) same (label or marking or	USPAT	2002/02/25 16:02
_	00000	indicia or code)	USFAT	2002/02/25 10.02
_	1052	((circuit or chip or semiconductor) same (label or marking or	USPAT	2002/02/25 16:06
	1002	indicia or code) ) and transparent and cover\$ and transmi\$	551 / 1	2002/02/20 10:00
		and mark\$ and identif\$		
_	227	((circuit or chip or semiconductor) same (label or marking or	USPAT	2002/02/25 16:14
	221	indicia)) and transparent and cover\$ and transmi\$ and	30.71	2002/02/20 10.14
		mark\$ and identif\$		
_	59	engrave\$ same surface same indicia and (chip or circuit or	USPAT	2002/02/25 16:19
	- 55	semiconductor)	551 71	2002/02/20 10.19
_	3008	(engrave\$ or form\$ or emboss) and (markings or indicia or	USPAT	2002/02/25 16:22
	5000	code\$) same surface same (chip or circuit or semiconductor)	301 71	2002/02/20 10.22
_	422	(engrave\$ or form\$ or emboss) and (markings or indicia or	USPAT	2002/02/25 16:24
	722	code\$) same surface same (chip or circuit or semiconductor)	JOFAI	. 2002102120 10.24
		and 235/\$.ccls.		
	<del>47</del> -	(engrave\$ or form\$ or emboss\$) and (marking\$ or indicia or	USPAT	2002/02/25 16:48
"	41	code\$) same surface same (chip or circuit or semiconductor)	USPAT	2002/02/25 10.40
		and 235/454.ccls.		]
<u> </u>	456	and 235/454.ccis.   (engrave\$ or form\$ or emboss\$ or etch\$) and (marking\$ or	LISDAT	2002/02/25 46-52
_	450	tengraves of forms or embosss or etchs) and (markings or indicia or codes) same surface same (chip or circuit or	USPAT	2002/02/25 16:52
		semiconductor) same identif\$		
<u> </u>	23	(engrave\$ or form\$ or emboss\$ or etch\$) and (marking\$ or	LICDAT	2002/02/25 17:02
-	23	indicia or code\$) same surface same (chip or circuit or	USPAT	2002/02/25 17:02
, l		semiconductor) same identif\$ and (transparent same cover)		
		semiconductor/same identità and (transparent same cover)	L	

-	47	(engrave\$ or form\$ or emboss\$ or etch\$ or record) and	USPAT	2002/02/25 17:34
	· · ·	(marking\$ or indicia or code\$ or data or information) same	001711	2502/02/25 17:54
		surface same (chip or circuit or semiconductor) same		
	426	identif\$ and (transparent same cover) (engrave\$ or form\$ or emboss\$ or etch\$ or record) and	USPAT	2002/02/25 17:43
-	420	(engraves or forms or embosss or etchs or record) and (markings or indicia or codes or data or information) same	USPAI	2002/02/25 17:43
		surface same (chip or circuit or semiconductor) same		
		identif\$ and cover		
_	65	(engrave\$ or form\$ or emboss\$ or etch\$ or record) and	USPAT	2002/02/25 17:47
		(marking\$ or indicia or code\$ or data or information) same	33,7,	2552,52,25 11:11
		surface same (chip or circuit or semiconductor) same		
		identif\$ same cover		
_	347	color same (barcode or "bar code") same identif\$	USPAT	2002/02/26 09:32
-	48	color\$ adj3 (barcode or "bar code") same identif\$	USPAT	2002/02/26 09:35
-	5	(color and (barcode or "bar code")).ti.	USPAT	2002/02/26 09:36
-	23	(color and (code or tag)).ti.	USPAT	2002/02/26 09:38
-	1246	"bar code" same color	USPAT	2002/02/26 09:38
-	332	"bar code" same color and 235/\$.ccls.	USPAT	2002/02/26 09:41
-	15	(("bar code" or tag or label) and color).ti.	USPAT	2002/02/26 09:47
-	23	"colored barcode" or "colored bar code"	USPAT	2002/02/26 10:44
-	4	"microlabel" same color\$	USPAT	2002/02/26 10:52
-	5020	5346738.pn. and bar	USPAT	2002/02/26 11:23
-	5039	(cover same transparent) and (code or label or tag or indicia)	USPAT	2002/02/26 11:23
-	1901 525	(transparent adj3 cover) and (code or label or tag or indicia) (transparent adj3 cover) same ("bar code" or tag or indicia or	USPAT USPAT	2002/02/26 11:26
-	525	(transparent adj3 cover) same ("bar code" or tag or indicia or   label)	USPAI	2002/02/26 11:32-
	13	transparent adj3 cover) same ("bar code") and chip	USPAT	2002/02/26 11:36
_	27	("transparent cover") same ("bar code")	USPAT	2002/02/26 11:39
_	81	cover same ("bar code") same protect\$	USPAT	2002/02/26 11:39
_	26	cover same ("bar code") same protect\$ same (clear or	USPAT	2002/02/26 11:46
	20	transparent)	0017(1	2002/02/20 11.40
_	44	cover same ("bar code" or indicia) same protect\$ same	USPAT	2002/02/26 11:58
		(semiconductor or circuit or chip)		``
-	44	cover same protect\$ same ("bar code" or barcde or indicia)	USPAT	2002/02/26 11:58
		same (semiconductor or circuit or chip)		
-	85	cover same protect\$ same (semiconductor or circuit or chip)	USPAT	2002/02/26 11:59
		same identif\$		
-	13	cover same protect\$ same (semiconductor or circuit or chip)	USPAT	2002/02/26 12:58
		same identif\$ same (transparent or translucent)		
•	1	5970321.pn.	USPAT	2002/02/26 13:00
-	1	(csp or ("chip scale packag\$")) same (protect\$ or cover)	USPAT	2002/02/26 13:04
	2	same (transparent or clear or translucent)	LICDAT	2002/02/26 42:07
-	2	(csp or ("chip scale package")) same (protect\$ or cover)	USPAT	2002/02/26 13:07
_	2	same (transparent or clear or translucent) (csp or ("chip scale")) same (protect\$ or cover) same	USPAT	2002/02/26 13:12
-		(csp or (chip scale )) same (protects or cover) same	JOSEAN	2002/02/20 13.12
_	1	(transparent or clear or translucent)   5118369.pn. and code	USPAT	2002/02/26 13:25
_	31386	"protective layer" or "protective coating" same code same	USPAT	2002/02/26 13:27
	0,000	(chip or circuit)	55. /(1	
_	6407	(protect\$ or encapsul\$) same (circuit or chip) same cover	USPAT	2002/02/26 13:27
-	128	(protect\$ adj layer) same indicia	USPAT	2002/02/26 13:34
-	6369	(protect\$ or encapsul\$) same (chip or circuit or	USPAT	2002/02/26 13:47
		semiconductor) and (mold\$ or print\$ or glb) and (transparent_		
		or translucent)		
-	57	(protect\$ adj layer) same indicia same (mold\$ or print\$ or	USPAT	2002/02/26 13:41
		glob)		
-	14935	(protect\$ or encapsul\$) same (chip or circuit or	USPAT	2002/02/26 14:01
		semiconductor) same (mold\$ or print\$ or glob or epoxy same		
		transparent)		
	2634	(protect\$ or encapsul\$) same (chip or circuit or	USPAT	2002/02/26 13:59
		semiconductor) same identif\$		
-	13	(protect\$ or encapsul\$) same (chip or circuit or	USPAT	2002/02/26 13:57
	40	semiconductor) same identif\$ same transparent same cover	LICDAT	2002/02/20 44:22
-	13	(protect\$ or encapsul\$) same (chip or circuit or	USPAT	2002/02/26 14:00
	L	semiconductor) same identif\$ same transparent same cover		

-	T 8	(protect\$ or encapsul\$) same (chip or circuit or	USPAT	2002/02/26 14:11
		semiconductor) same (mold\$ or print\$ or glob or epoxy)	33.7	
		same transparent same cover same identif\$		
_	336	(protect\$ or encapsul\$) same (chip or circuit or	USPAT	2002/02/26 14:13
		semiconductor) same (code or indicia or label) same identif\$	001 71	2002/02/20 14:10
	25	(protect\$ or encapsul\$) same (chip or circuit or	USPAT	2002/02/26 14:32
_	25	semiconductor) same (code or indicia or label) same identifs	001 71	2002/02/20 14.02
*		and cover and transparent		
	1	5279690.pn. and transparent	USPAT	2002/02/26 14:57
_	1070	mylar same color\$	USPAT	2002/02/26 14:57
_	1070	mylar adj color\$	USPAT	2002/02/26 15:09
-	0	5118369.pn. and silicon		
-	1	chip same color same identification	USPAT	2002/02/26 15:24
-	50		USPAT	2002/02/26 15:44
-	1489	color same identif\$ same (semiconductor or circuit)	USPAT	2002/02/26 15:45
-	24	identif\$ adj3 (semiconductor or circuit) adj3 color	USPAT	2002/02/26 15:49
-	74	identif\$ same semiconductor same color	USPAT	2002/02/26 16:01
-	3514	color adj2 code	USPAT	2002/02/26 16:03
-	824	(color adj2 code) same identif\$	USPAT	2002/02/26 16:03
-	67	(color adj2 code) same identif\$ same (circuit or chip or	USPAT	2002/02/26 16:10
		semiconductor)		
-	19	"color coded" adj3 (circuit or semiconductor or chip)	USPAT	2002/02/26 16:11
-	238	((mark\$3 or label\$3 or indicia) adj3 (semiconductor or circuit	USPAT	2002/07/31 10:11
		or integrated or chip)) same cover\$3		
-	15	(mark\$3 or label\$3 or indicia) adj3 (semiconductor or circuit	USPAT	2002/07/31 10:12
		or integrated or chip) adj3 (overlay\$3 or cover\$3)		
-	15	((mark\$3 or label\$3 or indicia) adj3 (semiconductor or circuit	USPAT	2002/07/31 10:42
		or integrated or chip)) adj3 cover\$3		
-	0	((mark\$3 or label\$3 or indicia) adj3 (semiconductor or circuit	USPAT	2002/07/31 10:44
		or chip)) same ((transparent or transmissive or translucent or		
		cover\$3) adj3 (irremovable or permanent))		
-	31	((mark\$3 or label\$3 or indicia) adj3 (semiconductor or circuit	USPAT	2002/07/31 11:08
		or chip or wafer or component or card or device)) same		
		((transparent or transmissive or translucent) adj3 (overlay\$3		
i		or cover\$3))		
_	4	5461545.pn. or 4300184.pn. or 5641997.pn. or 5479049.pn.	USPAT	2002/07/31 11:15
_	2	"encapsulation layer" same CSP	USPAT	2002/07/31 11:15
-	68	(coat\$3 or encapsulat\$3) same (layer or film) same (chip or	USPAT	2002/07/31 11:25
		circuit) same (transparent or translucent or transmissive)		
		same (indicia or label or mark\$4)		
_	118	(coat\$3 or encapsulat\$3) same (layer or film) same (chip or	USPAT	2002/07/31 11:26
		circuit or wafer or semiconductor) same (transparent or	1	2002/01/,01 11120
		translucent or transmissive) same (indicia or label or mark\$4)		
_	108	((coat\$3 or encapsulat\$3 or cover\$3) adj3 (layer or film or	USPAT	2002/07/31 11:29
	100	material\$3 or coat\$3)) same (chip or circuit or wafer or	00.71	2002/07/01 11:20
		semiconductor) same (transparent or translucent or		
	1	transmissive) same (indicia or label or mark\$4)		
_	102	((coat\$3 or encapsulat\$3 or cover\$3) adj3 (layer or film or	USPAT	2002/07/31 14:53
_	102	((coats) or encapsulats) or covers) adjo (layer or film or   material\$3 or coat\$3)) same (chip or circuit or wafer or	USPAI	2002/07/31 14.53
		semiconductor) same (transparent or translucent or transmissive) same (indicia or label or mark\$3)		
	<u> </u>	transmissive) same (indicia of label of markas)		